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PLEASE DELIVER TO EXAMINER T. PHAMDocket No. END920030018US1 (IEN-10-5765)

Applicant(s):

Serial No.	Filing Date	Examiner	Group Art Unit
<u>10/666,775</u>	<u>September 18, 2003</u>	<u>T. Pham</u>	<u>2813</u>

Invention:

METHOD OF FORMING A BOND PAD ON AN I/C CHIP AND RESULTING STRUCTURE

I hereby certify that this Supplemental Amendment After Final Rejection is being transmitted via facsimile to the United States Patent and Trademark Office

Fax. No. 571-273-8300 on August 18, 2005 5
(Date) (No. of pages)

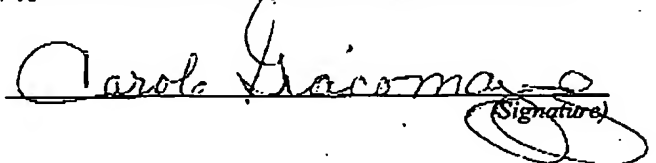
TO: Examiner Pham

Attached is a Supplemental Amendment After Final Rejection being filed in response to the Advisory Action issued July 26, 2005 in the above entitled application.

It is not believed that any fees are required. However, the Commissioner is hereby authorized to charge payment of fees associated with this communication, or credit any overpayment, to Deposit Account No. 09-0457.

FROM: William N. Hogg
CUSTOMER NO. 26681Carole Giacomazzo

(Typed or Printed Name of Person Signing Certificate)


(Signature)

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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of Biggs et al

Serial No.: 10/666,775

Filed: September 18, 2003

For: **METHOD OF FORMING A BOND PAD ON AN I/C
CHIP AND RESULTING STRUCTURE**) Examiner: T. Pham
)
) Art Unit: 2813
)
) Confirmation No. 9436
)
)

Docket No. END920030018US1 (IEN-10-5765)

SUPPLEMENTAL AMENDMENT AFTER FINAL REJECTIONMail Stop AF
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Responsive to the Examiner's Advisory Action of July 26, 2005 and supplementing the amendment after final rejection filed July 18, 2005, it is respectfully requested that the claims be amended as shown in the attached sheets.

END920030018US1 (IEN-10-5765)